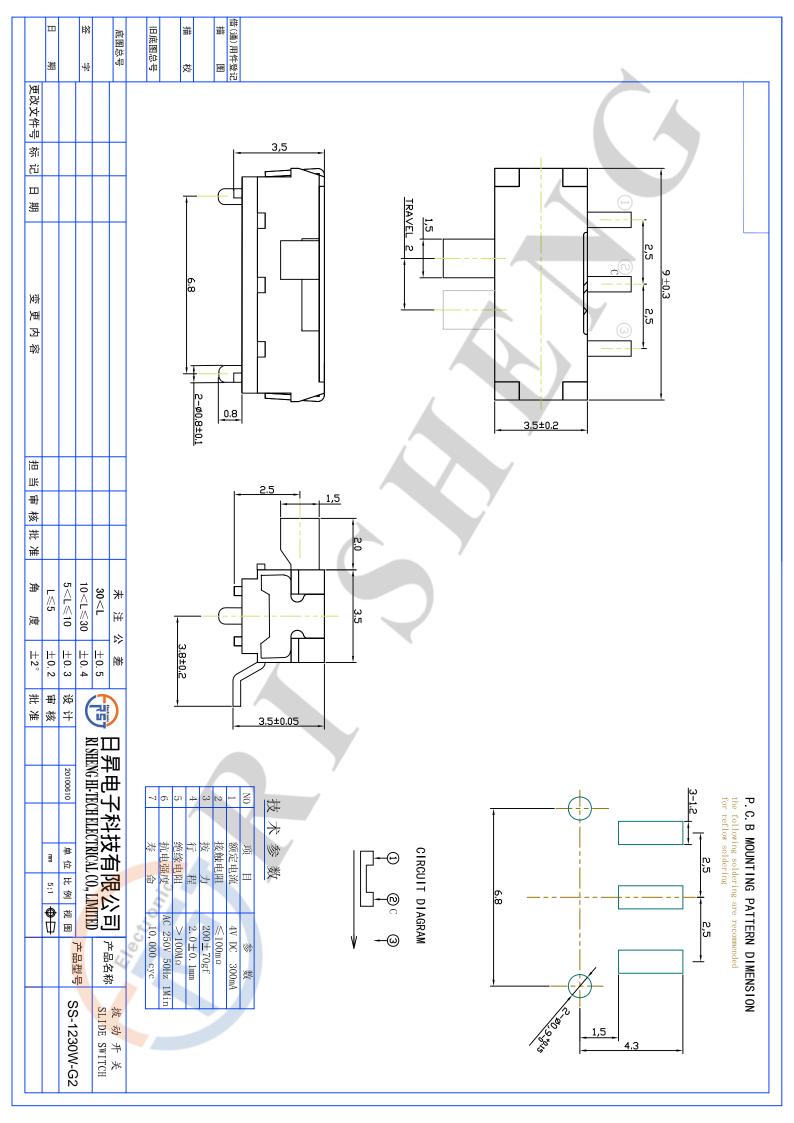
日昇電子科技有限公司 深圳市丰华日昇科技有限公司

RI SHENG HI-TECH ELECTRICAL CO., LIMITED TEL: 0755-29663560 FAX: 0755-29648851

承认书

Acknowledgment

| CUSTOMER NAME | 客户名称: | |
|---------------------------|--------------------|-------------|
| CUSTOMER PARTS | NO 客户料号: | |
| DESIGNATION | 系列: | |
| MODEL NO | 型号: | SS-1230W-G2 |
| DARWING NO | 图型号: | |
| FORDRAWING ON | 客户机种: | |
| | _ | |
| PLEASE CONFIRM | OUR SPECIFICATION. | 敬请确认规格书之内容。 |
| PLEASE CONFIRM | AND RETURN1COY. | 青确认后惠返(1)份。 |
| | | |
| APPROVAL STATUS | 审批 | |
| APPROVED 接受 | FAILED 不接受 | ; |
| | | |
| SIGNATURE 签署 | DATE 日期 | |
| OIOWIUW 亚有 | DAIL [179] | |
| DGN 制表人 CK | APPD审核 | |
| | | |
| 刘丽 | 张伟 | |
| DA <mark>TE</mark> 日期/ DA | TE 日期/ DATE 日期/ | NO |
| 0 | | |



- 1. General specification 基本事项
- 1.1 Switch action 开关种类: Slide Switch 拨动开关
- 1.2 Switch rating 最大额定值: DC 4V, 300mA
- 1.3 Operation temperature range 使用温度试验范围: -20℃~+85℃
- 1.4 Preservative temperature range 保存温度范围: -40℃~+85℃
- 1.5 Appearance and dimensions: See outside drawing page 外形尺寸: 见外形尺寸图
- 1.6 Standard condition :Unless otherwise specified ,the test and measurements shall be carried out as follows :试验、测定状态

Ambient temperature 温度: 5~35℃

Relative humidity 相对湿度: 45~85%

Air pressure 气压: 86~106kPa(860~1060mbar)

However , if doubt arises on the decision based on the measured

Values under the above-mentioned conditions, the following conditions be employed:

但是在对判定产生疑义时,按下述状态实施:

Ambient temperature 温度: 20±2℃

Relative humidity 相对湿度: 65±5%

Air pressure 气压: 86~106kPa(860~1060mbar)

2. Performance 性能

2.1Electrical characteristics 电气性能

| 2.112160 | trical characteristics 电 (注版 | | | |
|------------|--|--------------------------------|----------------------|---------------------------|
| | Item | Test cor | ndition | Performance |
| | 项 目 | 测试 | 规 格 | |
| 2.1.1 | Contact Resistance | Push force: (Operation force) | Κ2. | 100mΩ max. |
| | 接触电阻 | 测定时的负荷:操作方向动作 | F力基准值的 2 倍 | 100 毫歐以下。 |
| | | Measurement tool: Contact resi | stance meter | |
| | | 测定器:微电流接触电阻计。 | (1kHz,20mV,5~50mA) | |
| 2.1.2 | Insulation Resistance | DC 250V(Between terminals) | frame for 1 minute. | 100 Μ Ω min. |
| | 绝缘电阻 | 不相接的两端子间、端子与塑 | 提胶间施加 DC250V 电压,持 | 100 兆歐以上。 |
| | | 续1分钟测量 | | |
| 2.1.3 | Withstand Voltage | AC 250V (Between terminals) | frame for 1 minute. | No insulation destruction |
| | 耐电压 | 不相接的两端子间、端子与塑 | 提胶间施加 AC250V 电压,持 | 无绝缘破坏 |
| | | 续1分钟测量 | | |
| 2.1.4 | Bouncing | Operation speed:3~4times/s | ON: 5ms max 以下 | |
| | 触点抖动 | 操作速度:每秒3~4次 | OFF: 5ms max 以下 | |
| | Electronic | Switch DC 10V 10MA | Oscilloscope 示波 器 | |
| Electronic | 日昇电子科技有限公司 | WRITTEN BY | CHECKED BY | APPROVED BY |
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| | | | | |

| 2.2 Me | 2.2 Mechanical Characteristics 机械性能 | | | | |
|------------|---|------------------------------------|-----------------------------|---|--|
| | Item | Test condi | tion | Performance | |
| | 项 目 | 测试条件 | 牛 | 规 格 | |
| 2.2.1 | Operations Force | Push by recommended operating | ng condition. | $1.97 \pm 0.67 \text{N} \ (200 \pm 70 \text{gf})$ | |
| | 动作力 | 测量时,拨动开关动作方向均匀 |]施加静负荷。 | | |
| | | | | | |
| | | | | | |
| | | | | | |
| | | | | | |
| | | | | Y | |
| 2.2.2. | Travel to closure | Push by recommended operating c | condition | 2±0.1mm | |
| | 运作行程 | F=(Operation force)x2 | | | |
| | | 在开关的顶端的面中央沿开关动 | 7作方向施加2倍操作力测 | | |
| | | 量行程,测量仪器的顶端应平。 | | | |
| 2.2.3 | Kond strength | 30N (3Kgf) for 1 minute | 7 | No damage(Electrical and mechanical) | |
| 2.2.3 | 手柄强度 | 在开关驱动器件顶端中央,在拨 | 动力方向加 30N(3Kgf) | 无异常(电气、机械性能) | |
| | 7 117321/2 | 力,作用 60 秒。 | (737473 178H BOTT (BILBI) | 767 III (I () FEMILIA | |
| 2.2.4 | Vibration test | 1) Amplitude 全振幅: 1.5mm | | No.2.1 and 2.2.1 to 2.2.2 shall be | |
| | 耐振性 | 2) Sweep rate: 10-55-10Hz for 1 m | ninute | satisfied | |
| | | 扫描速度: 10-55-10Hz 1分钟 | | 满足 2.1 项和 2.2.1 至 2.2.2 项。 | |
| | | 3) Sweep method: Logarithmic fr | requency sweep rate | | |
| | | 扫描方式:对数频率扫描速度 | | | |
| | | 4) Vibration direction: X, Y, | Z (3 directions) | | |
| | | 振动方向: X、Y、Z(3方向) | | | |
| | | 5) Time: Each direction 2 hours | (Total 6 hours) | | |
| | | 时间:每个方向2个小时(共6 | 小时) | | |
| 2.2.5 | Soldering heat test | Soldering area: t/2 of P.W.B thick | tness | No damage (Electrical and | |
| | 耐焊接热 | (P.C.B:T=1.6mm) | | mechanical) | |
| | | 焊接面积: 印刷基板的 1/2 厚度 | 度处 | 无异常(电气、机械性能) | |
| | | Soldering temperature: 260±5°C | ; | | |
| | | 焊接温度: 260±5℃ | | | |
| | | Soldering time: 3±0.5sec | | | |
| | | 焊接时间: 3±0.5秒 | | | |
| 2.2.6 | Solderbility | After sprated flux | | 90% or more of surface area of the | |
| | 可焊性 | 涂上助焊剂后 | | portion immersed in solder shall be | |
| | . 5 | temperature: 245±5°C | | covered by new solder | |
| | | 温度: 245±5℃ | | 90%或更多的浸焊面积能被焊锡覆 | |
| E. | | Soldering time: 3 ± 0.5 sec | | 盖 | |
| | o o | 焊接时间: 3±0.5 秒 | | | |
| Electronic | 日昇电子科技有限公司 | WRITTEN BY | CHECKED BY | APPROVED B Y | |
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| 2.3 C1 | imatic characteristics 耐修 | <u></u> | | |
|--------|--|--|----------------------------|------------------------------------|
| | Item | Test condit | ion | Performance |
| 项 目 | | 测试条件 | | 规 格 |
| 2.3.1 | 3.1 Cold test 1) Temperature: $-40\pm2^{\circ}$ C | | | No.2.1 and 2.2.1 to 2.2.2 shall be |
| | 耐寒性 | 温度: -40±2℃ | | satisfied |
| | | 2) Duration of test: 96h | | 满足 2.1 项和 2.2.1 至 2.2.2 项。 |
| | | 持续时间: 96 小时 | | |
| | | 3) Take off a drop water | | |
| | | 去掉水珠 | | |
| | | 4) Standard conditions afte | er test:1h | |
| | | 试验后的放置条件: 1 小时 | | y |
| 2.3.2 | Heat test | 1) Temperature: 80±2°C | | No.2.1 and 2.2.1 to 2.2.2 shall be |
| | 耐热性 | 温度: 80±2℃ | | satisfied |
| | | 2) Duration of test: 96h | | 满足 2.1 项和 2.2.1 至 2.2.2 项。 |
| | | 持续时间: 96 小时 | | |
| | | 3) Standard conditions after test :1 | lh | |
| | | 试验后的放置条件: 1 小时 | | |
| 2.3.3 | TEMPERATURE CYCLIG | According to following figure, | after 5cycles, test after | No.2.1 and 2.2.1 to 2.2.2 shall be |
| | TEST | keeping in normal condition for 30 | satisfied | |
| | 温度交变试验 | 如图示环境中,循环 5 次后,放 | 满足 2.1 项和 2.2.1 至 2.2.2 项。 | |
| | | | | |
| | | +85°C | / | |
| | | | 7 | |
| | | | IX. | |
| | | 1005 | / | |
| | | -40°C | One_cycle | |
| | | $\begin{bmatrix} 2 & 1 & 2 \\ \vdots & \vdots & \ddots & \vdots \end{bmatrix}$ | 1 Hours | |
| | | | 7 7 | |
| 2.3.4 | Humidity test | 1) Temperature: 60±2℃ | | No.2.1 and 2.2.1 to 2.2.2 shall be |
| | 耐湿性 | 温度: 60±2℃ | | satisfied |
| | | 2) Relative humidity:90~95% | | 满足 2.1 项和 2.2.1 至 2.2.2 项。 |
| | | 相对湿度: 90~95% | | |
| | | 3) Duration of test: 96h | | |
| | | 持续时间: 96 小时 | | |
| | | 4) Take off a drop water | | |
| | | 去掉水珠 | | |
| | | 5) Standard conditions after | | |
| | .0 | 试验后的放置条件: 1 小时 | | |
| | 」 <mark>∃</mark> 昇电子科技有限公司 | WRITTEN BY | CHECKED B Y | APPROVED BY |
| | コチャセコイイが、同Pは公で」 RISHENG HI-TECH ELECTRICAL CO., LIMITED | | | |
| | | | | |

| | Item | Test cor | adition | Performance |
|--------|---|--|------------------------|---|
| | 项 目 | lest col 测试 | | 规 格 |
| 2.3.5 | | | | Contact resistance: 200m Ω max |
| 2.3.3 | Endurance (switching) | 1) Operation speed: 20-30tir | He/IIIII | 接触电阻: 200 m Ω 以下 |
| | action | 动作速度: 20-30 次/分钟 | 1 6 2 6 | |
| | 耐久特性(开关寿命) | 2) Push force: Maximum va | lue of operation force | Bouncing: 10 ms max |
| | | 按力:动作力规格值的上限 | | 触点抖动:: 10毫秒以下 |
| | | 3) Operation number: 10, 0 | 000 times | Insulation resistance: 100M Ω min |
| | | 动作次数: 10,000次 | | 绝缘电阻: DC. 250V, 大于 100M Ω |
| | | | A | Withstand voltage :No. |
| | | | | destruction. |
| | | | | 耐电压: 无绝缘破坏。 |
| | | | | Variations rate of operation |
| | | | | force shall be within $\pm 30\%$ to the |
| | | | | value be fore testing |
| | | | | 动作力的变化范围在初始值的±30% |
| | | | | 以内 |
| | | | | 2.2.2 shall be satisfied |
| | | | | 满足 2. 2. 2 项 |
| .2.3.6 | Withstand H2S | 1) Density: 3 ± 1 ppm | | No.2.1 and 2.2.1 to 2.2.2 shall be |
| | 耐 H2S | 浓度: 3±1ppm | | satisfied |
| | | 1) Temperature: 40±2°C | 7 | 满足 2.1 项和 2.2.1 至 2.2.2 项。 |
| | | 温度: 40±2℃ | , | |
| | | 2) Relative humidity:90~9 | 95% | |
| | | 相对湿度: 90~95% |) | |
| | | 3) Duration of test: 12h | | |
| | | 持续时间: 12 小时 | | |
| | | 4) Standard conditions af | ter test:1h | |
| | | 试验后的放置条件: 1 小时 | | |
| 2.3.7 | Salt mist | At 5% Nacl liquor for 8 ho | * | No remarkable corrosion shall be |
| | 雾实验 | washing , keep in normal co | | recognized in metal part. |
| | | 5% 的 Nacl 溶液, PH 值: 6.5 | | 在金属件上没有腐蚀斑点。 |
| | | 雾8小时。用清水洗干净后并 | F在室温下晾干 | |
| 2.3.8 | Shock | Peak acceleration: 500m/S ² | | No.2.1 and 2.2.1 to 2.2.2 shall be |
| | 耐冲击性 | 冲击加速度: 500m/S ² | | satisfied |
| | | 脉冲持续时间 11ms | | 满足 2.1 项和 2.2.1 至 2.2.2 项。 |
| | | Test time-6direction, each | | |
| | C) | 测试次数-6个方向,各3次共 | 共计 18 次 | |
| | | | | |
| | 5 | | | |
| | S | | | |
| | W. | 1 | | |
| | | - | | |
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| | I SHENG HI-TECH ELECTRICAL CO., LIMITED | | | |

3. Precaution 注意事项

3.1Soldering condition 浸焊条件

| 3.1Soldering condition 没焊 | | | |
|---------------------------|--|--|--|
| Item 项 目 | Condition 测试条件 | | |
| Preheat temperature | 110°C max (Embilomental temperature of soldering surface of P.C.B) | | |
| 预热温度 | 110℃以下(印刷基板焊锡周围的温度) | | |
| Preheat time | 60 sec, max | | |
| 预热时间 | 60 秒以内 | | |
| Area of flux | 1/2 max of P.C.B. thickness | | |
| 助焊剂面积 | 印刷基板厚度的 1/2 以内 | | |
| Temperature of solder | 260±5℃ max | | |
| 焊锡温度 | 260±5℃ 以下 | | |
| Times of immersion | Within 5 sec | | |
| 浸焊时间 | 5 秒以内 | | |
| Soldering number | Within 2 times (But should bring down heat of the first soldering) | | |
| 浸焊次数 | 2次以内(但应把第一次焊锡的温度降下来) | | |
| Printed wiring board | Single sided copper- clad laminates | | |
| 印刷基板 | 单面铜箔 | | |
| | | | |
| | | | |
| | | | |

1) After switches were soldered, please be careful not to clean switches with solvent

开关浸焊后,注意不要用溶剂清洗。

2) In the case of using soldering iron, soldering conditions shall be 280℃ max and 3 sec max. 在使用铬铁的情况下,焊锡温度应在 280℃以下、3 秒以内。

3) Right after switches were soldered; please be careful not to load on the knobs of switches. 浸焊后,注意不要在手柄顶部施加负荷。

- 3.2 Design instructions (设计中应注意事项)
- 1) Follow recommended P.C.B. piercing plan in the outside drawing page.

印刷基板的安装孔尺寸参见产品图

- 3.3 Note (注意点)
- 1) Please be cautious not to give excessive static load or shock to switches.

注意不要施加超过负荷的压力或晃动开关。

2) Please be careful not to pile up P.C.B. after switches were soldered.

开关焊接以后,印刷基板注意不要叠放。

3) Preservation under high temperature and high humidity or corrosive gas should be avoided especially. When you need to preserve for a long period, do not open the carton.

保管时尤其应注意避开高湿高温和有腐蚀性气体的环境,如需长时间保存,请不要打开包装箱。

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| 4. | Specification | 材质 |
|----|----------------------|----|
|----|----------------------|----|

| NO | Part Name | QT'Y | Material | Specification | |
|----|-----------|------|----------|---------------|-----|
| | 名称 | 数量 | 颜 色 | 材 质 | |
| 1 | 盖板 | 1 | 本色 | 不锈钢 | |
| 2 | 按钮 | 1 | 黑色 | PA | |
| 3 | 簧片 | 2 | 银白色 | 磷青铜度银 | A Y |
| 4 | 基座 | 1 | 黑色 | PA | |
| 5 | 端子 | 1 | 银白色 | 黄铜镀银 | |



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